









# PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 1206 1.1t Series
- ► Red (630nm) / Green (574nm)

N0D25S70



# **1206 1.1t Series**





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## **APPLICATIONS:**

- Indication Light
- Switch light
- Dashboard
- Keyboard
- **Consumer Goods**

# Package: PCB SMT Package Top View Duo Colours

Forward Current: 20/20mA\* Forward Voltage (typ.): 1.9/2.1V

Luminous Intensity (typ.): 90/32mcd @20mA

Colour: Red/Green Wavelength: 630/574nm Viewing angle: 140/140°

**Materials:** 

**FEATURES:** 

Die: AlGaInP/AlGaInP Resin: Epoxy (Water Clear) Operating Temperature: -40~+85°C Storage Temperature: -40~+100°C

ESD: 2000/2000V

- **Grouping parameters:** 
  - Forward voltage
  - Luminous intensity
  - **Dominant Wavelength**
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with 3000/reel, ø180mm (7")

<sup>\*</sup> in the order of Red/Green



# **CHARACTERISTICS:**

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	25/25*	mA
Peak Forward Current Duty 1/10@10KHz	I <sub>FP</sub>	75/60	mA
Reverse Current @5V	I <sub>R</sub>	10/10	μΑ
Power Dissipation	PD	60/65	mW
Electrostatic Discharge	ESD	2000/2000	V
Operating Temperature	T <sub>OPR</sub>	-40~+85	°C
Storage Temperature	T <sub>STG</sub>	-40~+100	°C

<sup>\*</sup> in the order of Red/Green

# Electrical & Optical Characteristics (Ta=25°C)

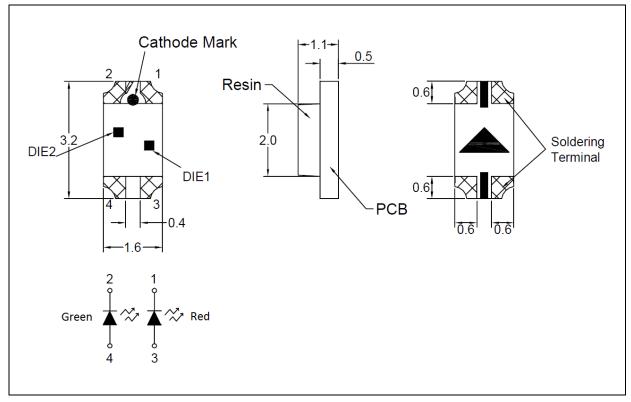
Parameter	Symbol		Values			Test
Parameter	Зуппоп	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V <sub>F</sub>	1.5/1.7		2.4/2.6	V	I <sub>F</sub> =20mA
Luminous Intensity	I <sub>V</sub>	32/20	80/32	200/125	mcd	I <sub>F</sub> =20mA
Dominant Wavelength	$\lambda_{D}$		630/574		nm	I <sub>F</sub> =20mA
Spectral Line Half Bandwidth	Δλ		20/20		nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		140/140		deg	I <sub>F</sub> =20mA

<sup>1.</sup> Luminous intensity ( $I_V$ ) ±15%, Forward Voltage ( $V_F$ ) ±0.1V



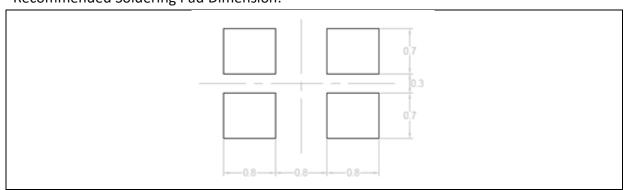
# **OUTLINE DIMENSION:**

# Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

# **Recommended Soldering Pad Dimension:**



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



# **BINNING GROUPS:**

# Forward Voltage Classifications (I<sub>F</sub> = 20mA):

Code	Min.	Max.	Unit
Red	1.5	2.4	V
Green	1.7	2.6	V

# Luminous Intensity Classifications ( $I_F = 20mA$ ):

Со	de	Min.	Max.	Unit
	N	32	50	
Dod	Р	50	80	
Red	Q	80	125	mcd
	R	125	200	

Green	М	20	32	
	N	32	50	mcd
	Р	50	80	
	Q	80	125	

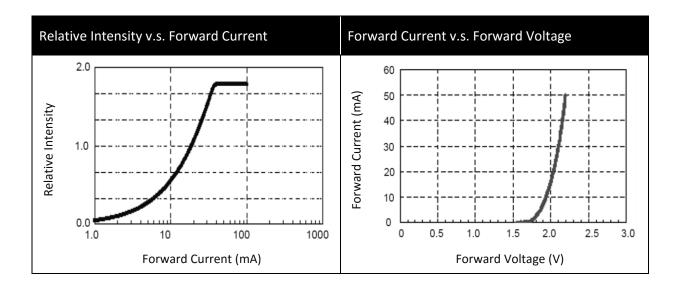
# Dominant Wavelength Classifications ( $I_F = 20 \text{mA}$ ):

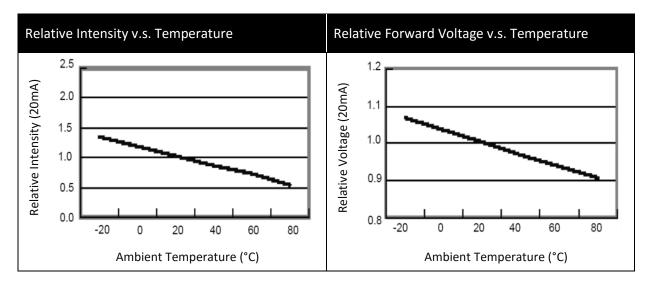
Со	de	Min.	Max.	Unit
	29	624	627	
	30	627	630	
Red	31	630	633	nm
	32	633	636	

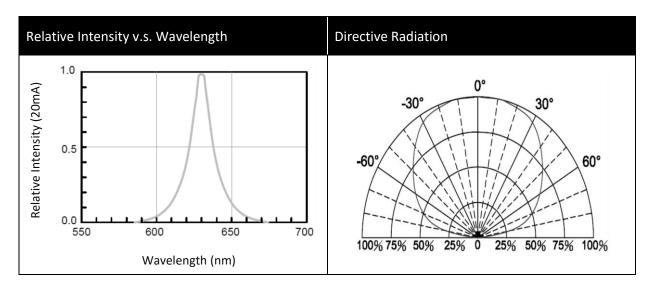
Green	6	566	568	
	7	568	570	
	8	570	572	nm
	9	572	574	
	10	574	576	



# **ELECTRO-OPTICAL CHARACTERISTICS (RED):**



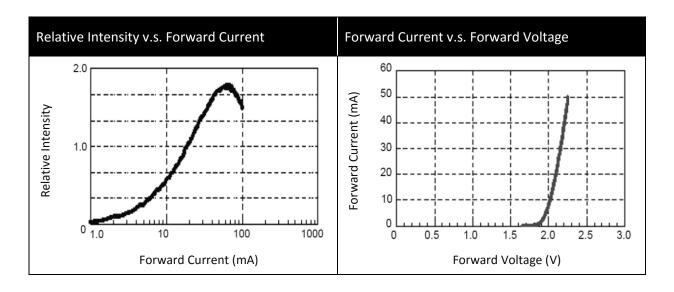


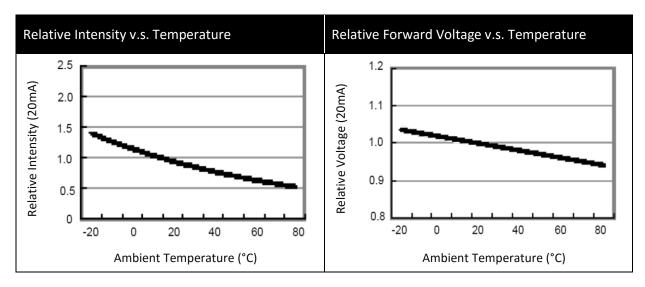


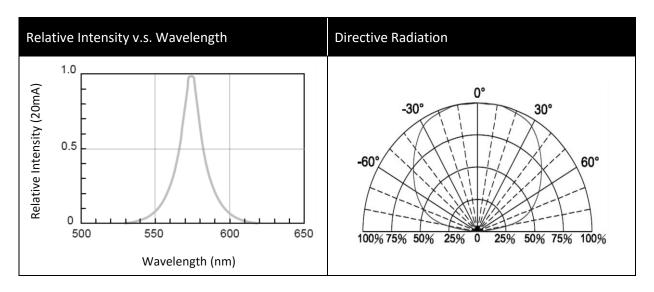
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# **ELECTRO-OPTICAL CHARACTERISTICS (GREEN):**



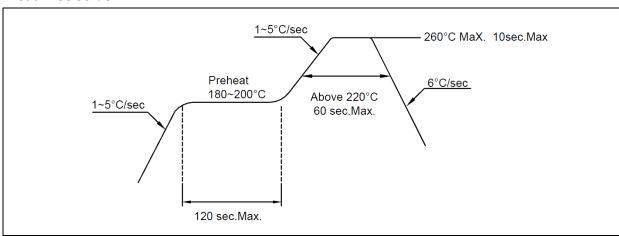






# **RECOMMENDED SOLDERING PROFILE:**

## Lead-free Solder:



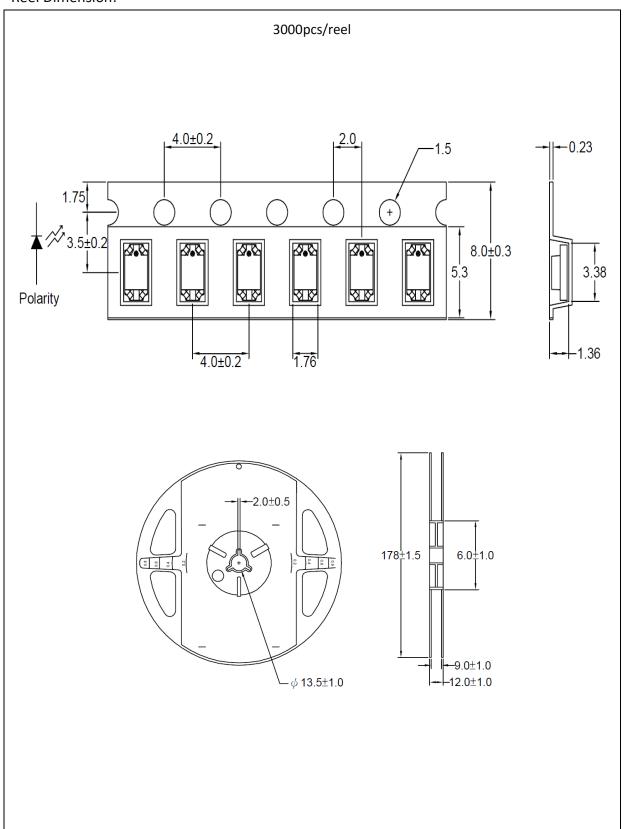
#### Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



# **PACKING SPECIFICATION:**

## Reel Dimension:





#### **PRECAUTIONS OF USE:**

#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~35°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

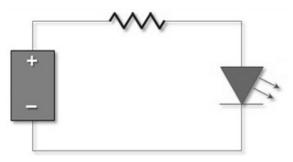
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 15hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

## **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

# ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	20/09/2016	Datasheet set-up.